## What is claimed is:

- A substrate processing apparatus comprising:
- a processing chamber for accommodating a substrate therein;
  - a mounting table for mounting the substrate thereon;
  - a heating member disposed in the mounting table, for heating the substrate;
- a sealing member disposed between the mounting table and the processing chamber; and
  - a cooling unit, having a cooling medium, for cooling the sealing member by using a latent heat of vaporization of the cooling medium included therein.
- 2. The apparatus of claim 1, wherein the cooling unit includes a depressurized airtight casing for accommodating the cooling medium therein.
- 3. The apparatus of claim 1, further comprising a temperature sensor disposed near the sealing member and a cooling unit controller for controlling the cooling unit based on a measurement result of the temperature sensor.
- The apparatus of claim 1, further comprising a
  processing gas supply system for supplying a processing gas into the processing chamber.



- 5. The apparatus of claim 4, wherein the processing gas supply system includes a plurality of processing gas supply units for supplying different processing gases and a processing gas supply unit controller for controlling each of the processing gas supply units such that the processing gases are supplied alternately.
- 6. (Amended) A substrate processing apparatus comprising:
- a processing chamber for accommodating a substrate therein:
- a mounting table having a mounting portion for mounting thereon the substrate and a support for supporting the mounting portion;
- a heating member disposed in the mounting portion, for heating the substrate;
- a sealing member disposed between the support and the processing chamber;
- a shielding member for shielding a heat radiation directed toward the sealing member from the mounting portion; and
- a shielding cap covering a bottom portion of the support.
- 7. The apparatus of claim 6, wherein the shielding member covers at least a part of a bottom surface of the mounting portion.



8. The apparatus of claim 6, further comprising a

substrate elevating member for elevating the substrate, wherein the shielding member supports the substrate elevating member.

- 9. The apparatus of claim 6, further comprising a processing gas supply system for supplying a processing gas into the processing chamber.
- 10. The apparatus of claim 9, wherein the processing gas supply system includes a plurality of processing gas supply units for supplying different processing gases and a processing gas supply unit controller for controlling each of the processing gas supply units such that the processing gases are supplied alternately.

15